



General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

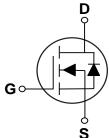
BV _{DSS}	R _{DS(ON)}	I _D
30 V	1.2 mΩ	240 A

Features

- $R_{DS(ON)} \le 1.2 m\Omega @V_{GS} = 10V$
- · Fast switching
- · Improved dv/dt capability
- · Green Device Available

PPAK5X6 Pin Configuration





Applications

- Networking
- · Load Switch
- · LED applications

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	+20 / -12	V
1	Drain Current - Continuous (T _C =25°C)	240	Α
I _D	Drain Current - Continuous (T _C =100°C)	150	Α
I _{DM}	Drain Current - Pulsed (NOTE 1)	960	Α
EAS	Single Pulse Avalanche Energy (NOTE 2)	423	mJ
IAS	Single Pulse Avalanche Current (NOTE 2)	92	Α
P_{D}	Power Dissipation (T _C =25°C)	178	W
гр	Power Dissipation - Derate above 25°C	1.43	W/°(
T _J	Operating Junction Temperature Range	-50 to 150	°C
T _{STG}	Storage Temperature Range	-50 to 150	°C
/larking Code		NC1P2	

Thermal Characteristics					
Symbol Parameter Typ.				Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		62	°C/W	
$R_{\theta JC}$	Thermal Resistance Junction to Case		0.7	°C/W	





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	30			V
I _{DSS}	IDrain-Source Leakage Current	V_{DS} =30V , V_{GS} =0V , T_J =25°C			1	uA
		V _{DS} =24V , V _{GS} =0V , T _J =125°C			10	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS} =+20V , V_{DS} =0V			100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	IStatic Drain-Source On-Resistance	V_{GS} =10V , I_D =30A		1.0	1.2	mΩ
		V_{GS} =4.5V , I_D =15A		1.5	2.2	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1.0	1.6	2.5	V
gfs	Forward Transconductance	V _{DS} =10V , I _D =3A		28		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge	V _{DS} =15V , V _{GS} =10V , I _D =30A - (NOTE 3 \ 4)		65	130	
Q_{gs}	Gate-Source Charge			18	36	nC
Q_{gd}	Gate-Drain Charge	(10123 4)		8.5	17	į
$T_{d(on)}$	Turn-On Delay Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω , I_{D} =1A (NOTE 3 \ 4)		19	38	
T _r	Rise Time			12	24	nS
$T_{d(off)}$	Turn-Off Delay Time			62	124	113
T_f	Fall Time			130	260	
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , F=1MHz		5620	11200	
C _{oss}	Output Capacitance			2165	4200	pF
C _{rss}	Reverse Transfer Capacitance			46	92	
R_g	Gate resistance	V_{GS} =0V , V_{DS} =0V , f=1MHz		1.5		Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V , Force Current			240	Α
I _{SM}	Pulsed Source Current				480	Α
V_{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25°C			1	V

NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =92A, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C.
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- ${\bf 4.} \ Essentially \ independent \ of \ operating \ temperature.$





Characteristics Curves

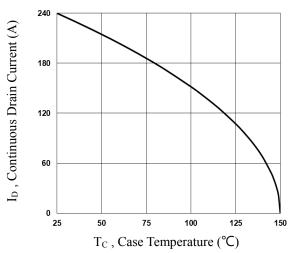


Fig.1 Continuous Drain Current vs. T_c

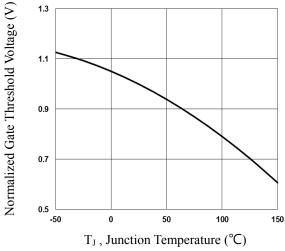
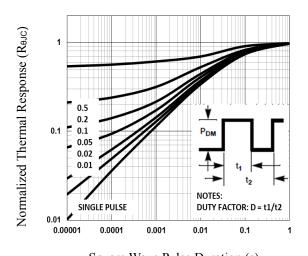


Fig.3 Normalized V_{th} vs. T_J



Square Wave Pulse Duration (s)

Fig.5

Normalized Transient Impedance

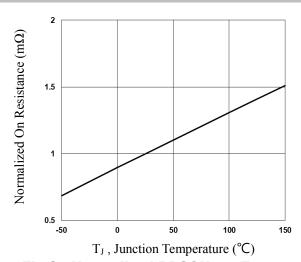


Fig.2 Normalized RDSON vs. T_J

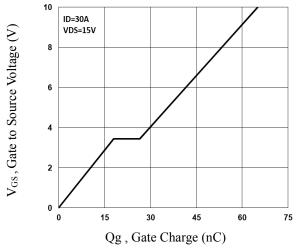
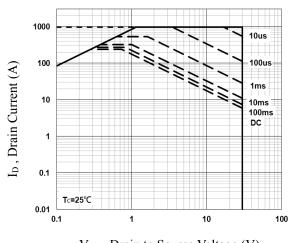


Fig.4 Gate Charge Characteristics



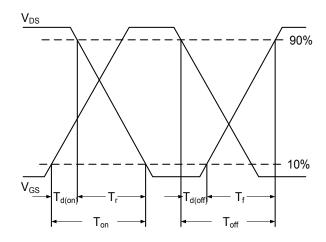
V_{DS} , Drain to Source Voltage (V)

Fig.6 Maximum Safe Operation Area





Characteristics Curves



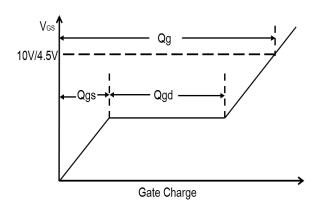
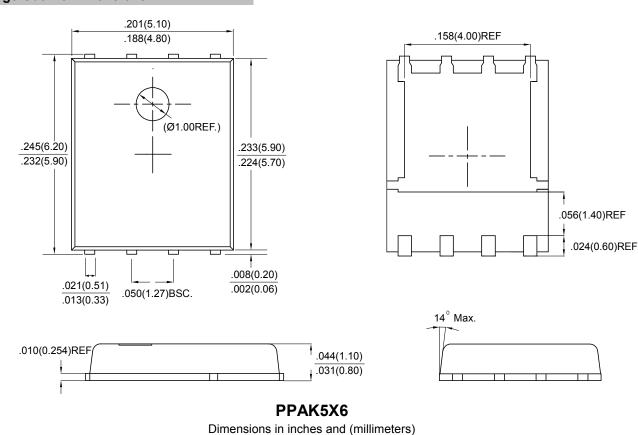


Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform

Package Outline Dimensions







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